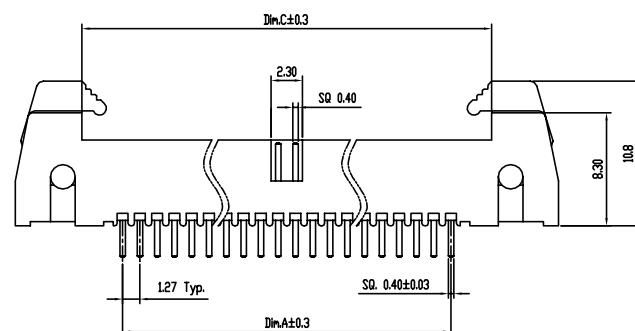
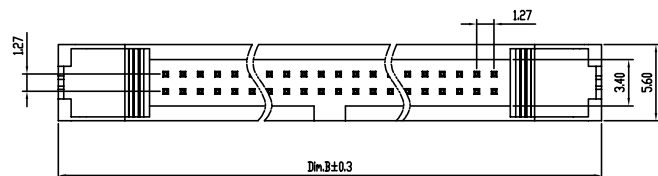
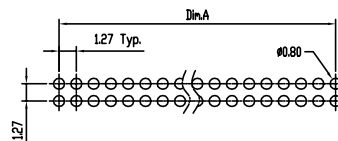


TABLE 1

DASH No.	Dim.	Amount of Pins	Dim.A	Dim.B	Dim.C
-000 06 XX LF	6	2.54	18.31	8.46	
-000 10 XX LF	10	5.08	20.85	11.00	
-000 12 XX LF	12	6.35	22.12	12.27	
-000 14 XX LF	14	7.62	23.39	13.54	
-000 16 XX LF	16	8.89	24.66	14.81	
-000 20 XX LF	20	11.43	27.20	17.35	
-000 26 XX LF	26	15.24	31.01	21.16	
-000 30 XX LF	30	17.78	33.55	23.70	
-000 34 XX LF	34	20.32	36.09	26.24	
-000 40 XX LF	40	24.13	39.90	30.05	
-000 44 XX LF	44	26.67	42.44	32.59	
-000 50 XX LF	50	30.48	46.25	36.40	
-000 60 XX LF	60	36.83	52.60	42.75	
-000 64 XX LF	64	39.37	55.14	45.29	
-000 66 XX LF	66	40.64	56.41	46.56	
-000 68 XX LF	68	41.91	57.68	47.83	

Recommended P.C.B. Layout (2)
Layout Tolerance = ± 0.05 mm

NOTE:

- MATERIAL,
HOUSING: HIGH TEMP PLASTIC, UL94-V0, BLACK
TERMINAL: COPPER ALLOY, SQ=0.40±0.03MM
- FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER 1um(40u") MIN Ni OVER ALL
- SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1420
- THE HSG. WILL WITHSTAND EXPOSURE TO 260C
PEAK TEMP. FOR 10 SEC. IN A WAVE SOLDER APPLICATION
WITH A PCB.
- PRODUCT NUMBERING:
20021611 - 0 0 0 XX X X LF

LEAD FREE

PLATING:

1:GOLD FLASH ALL OVER

4:0.25um(10U")GOLD AT CONTACT

8:0.76um(30U")GOLD AT CONTACT

9:1u" GOLD OVER 30u" PdNi AT CONTACT

PACKING

T: TUBE

PIN COUNT
SEE TABLE 1

mat'l. code				surface		tolerance		projection		product family					
				ISO1302 ✓		ISO1101 ISO406				MINITEK					
ltr ecn nodr		date		tolerances unless otherwise specified						title					
A T09-1117		S.LIN 09/15/09		angle line 0°±2'		0.X±0.38		 MM		1.27X1.27MM BTB EJECT HEADER VERTICAL TH					
B T10-0025		S.LIN 01/20/10				0.XX±0.25									
C BX-N-010365		ZK 01/16/12				0.XXX±0.10								scale 2:1	
				dr		STERLING LIN		09/15/09		dwg no		sheet 1 of 1		size	
				engr		STERLING LIN		09/15/09				20021611		A4	
				chr		GRAY HSIEH		09/15/09							
				appd		JOSEPH		09/15/09				type		Product Customer Drawing	
sheet index		revision		C											
		sheet 1													